74LV393-Q100

Dual 4-bit binary ripple counter Rev. 2 — 17 September 2014

Product data sheet

General description 1.

The 74LV393-Q100 is a low-voltage Si-gate CMOS device and is pin and function compatible with 74HC393-Q100 and 74HCT393-Q100.

The 74LV393-Q100 is a dual 4-stage binary ripple counter. Each counter features a clock input (nCP), an overriding asynchronous master reset input (nMR) and 4 buffered parallel outputs (nQ0 to nQ3). The counter advances on the HIGH-to-LOW transition of nCP. A HIGH on nMR clears the counter stages and forces the outputs LOW, independent of the state of $n\overline{CP}$.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. **Features and benefits**

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - ◆ Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Optimized for low voltage applications: 1.0 V to 3.6 V
- Accepts TTL input levels between V_{CC} = 2.7 V and V_{CC} = 3.6 V
- Typical V_{OLP} (output ground bounce) 0.8 V at V_{CC} = 3.3 V, T_{amb} = 25 °C
- Typical V_{OHV} (output V_{OH} undershoot) 2 V at V_{CC} = 3.3 V, T_{amb} = 25 °C
- Two 4-bit binary counters with individual clocks
- Divide-by any binary module up to 28 in one package
- Two master resets to clear each 4-bit counter individually
- Complies with JEDEC standard no. 7A
- ESD protection:
 - ◆ MIL-STD-883, method 3015 exceeds 2000 V
 - ♦ HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)

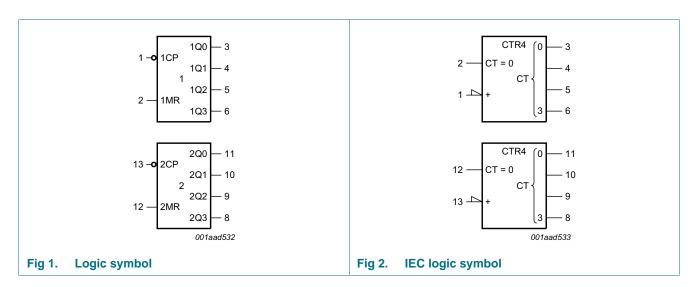
Ordering information 3.

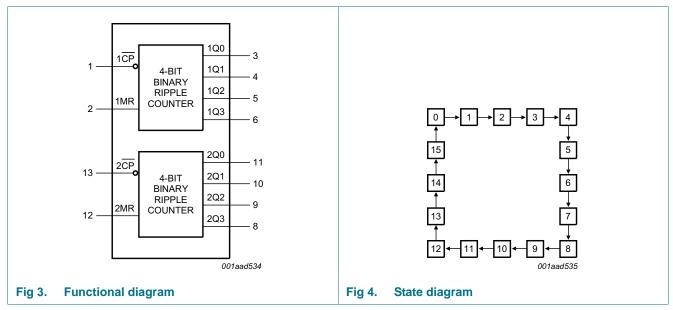
Table 1. **Ordering information**

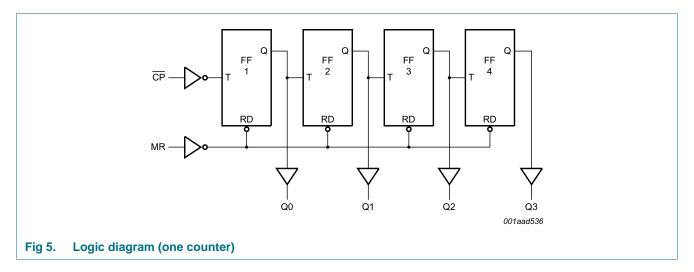
Type number	Package									
	Temperature range	Name	Description	Version						
74LV393D-Q100	-40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1						
74LV393PW-Q100	-40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1						



4. Functional diagram

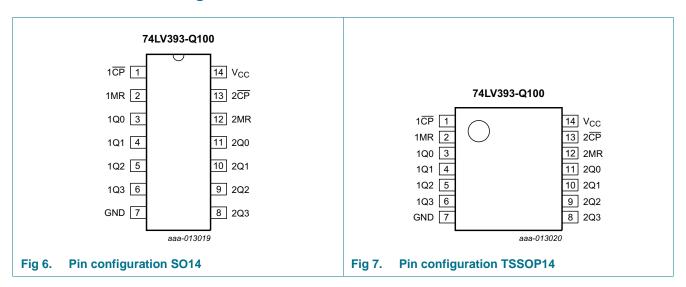






5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1CP	1	clock input (HIGH-to-LOW, edge-triggered)
1MR	2	asynchronous master reset input (active HIGH)
1Q0	3	flip-flop output
1Q1	4	flip-flop output
1Q2	5	flip-flop output
1Q3	6	flip-flop output
GND	7	ground (0 V)
2Q3	8	flip-flop output
2Q2	9	flip-flop output
2Q1	10	flip-flop output
2Q0	11	flip-flop output
2MR	12	asynchronous master reset input (active HIGH)
2CP	13	clock input (HIGH-to-LOW, edge-triggered)
V _{CC}	14	supply voltage

6. Functional description

Table 3. Count sequence for one counter [1]

Count	Output			
	nQ0	nQ1	nQ2	nQ3
0	L	L	L	L
1	Н	L	L	L
2	L	Н	L	L
3	Н	Н	L	L
4	L	L	Н	L
5	Н	L	Н	L
6	L	Н	Н	L
7	Н	Н	Н	L
8	L	L	L	Н
9	Н	L	L	Н
10	L	Н	L	Н
11	Н	Н	L	Н
12	L	L	Н	Н
13	Н	L	Н	Н
14	L	Н	Н	Н
15	Н	Н	Н	Н

^[1] H = HIGH voltage level; L = LOW voltage level.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+4.6	V
I _{IK}	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$		-	±20	mA
I _{OK}	output clamping current	$V_{O} < -0.5 \text{ V or } V_{O} > V_{CC} + 0.5 \text{ V}$		-	±50	mA
Io	output current	$V_{O} = -0.5 \text{ V to } V_{CC} + 0.5 \text{ V}$		-	±25	mA
I _{CC}	supply current			-	+50	mA
I _{GND}	ground current			-50	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	SO14 package	<u>[1]</u>	-	500	mW
		TSSOP14 packages	[2]	-	400	mW

^[1] For SO14 package: P_{tot} derates linearly with 8 mW/K above 70 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.0	3.3	3.6	V
VI	input voltage		0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 1.0 V to 2.0 V	-	-	500	ns/V
		$V_{CC} = 2.0 \text{ V to } 2.7 \text{ V}$	-	-	200	ns/V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	100	ns/V

^[2] For TSSOP14 packages: Ptot derates linearly with 5.5 mW/K above 60 °C.

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	_
V _{IH}	HIGH-level input voltage	V _{CC} = 1.2 V	0.9	-	-	0.9	-	V
		V _{CC} = 2.0 V	1.4	-	-	1.4	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V_{IL}	LOW-level input voltage	V _{CC} = 1.2 V	-	-	0.3	-	0.3	V
		V _{CC} = 2.0 V	-	-	0.6	-	0.6	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V _{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}						
		$I_O = -100 \mu A; V_{CC} = 1.2 V$	-	1.2	-	-	-	V
		$I_O = -100 \mu A; V_{CC} = 2.0 V$	1.8	2.0	-	1.8	-	V
		$I_{O} = -100 \mu A; V_{CC} = 2.7 V$	2.5	2.7	-	2.5	-	V
		$I_O = -100 \mu A; V_{CC} = 3.0 V$	2.80	3.0	-	2.8	-	V
		$I_{O} = -6 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.40	2.82	-	2.20	-	V
V _{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}						
		$I_O = 100 \mu A; V_{CC} = 1.2 V$	-	0	-	-	-	V
		$I_O = 100 \mu A; V_{CC} = 2.0 V$	-	0	0.2	-	0.2	V
		$I_O = 100 \mu A; V_{CC} = 2.7 V$	-	0	0.2	-	0.2	V
		$I_O = 100 \mu A; V_{CC} = 3.0 V$	-	0	0.2	-	0.2	V
		$I_{O} = 6 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	0.25	0.40	-	0.50	V
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 3.6 \text{ V}$	-	-	1.0	-	1.0	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 3.6$ V	-	-	20.0	-	160	μΑ
Δl _{CC}	additional supply current	quiescent per input $V_I = V_{CC} - 0.6 \text{ V};$ $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	500	-	850	μА
Cı	input capacitance		-	3.5	-	-	-	pF

^[1] All typical values are measured at T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); $C_L = 50$ pF unless otherwise specified; for test circuit, see <u>Figure 10</u>.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation delay	nCP to nQ0; see Figure 8	[3]						
		V _{CC} = 1.2 V		-	75	-	-	-	ns
		V _{CC} = 2.0 V		-	26	49	-	60	ns
		V _{CC} = 2.7 V		-	19	36	-	44	ns
		V _{CC} = 3.3 V, C _L = 15 pF		-	12	-	-	-	ns
		V _{CC} = 3.0 V to 3.6 V		-	14	29	-	35	ns
		nQ to nQn+1; see Figure 8	[3]				1	1	
		V _{CC} = 1.2 V		-	25	-	-	-	ns
		V _{CC} = 2.0 V		-	9	17	-	20	ns
		V _{CC} = 2.7 V		-	6	13	-	15	ns
		$V_{CC} = 3.3 \text{ V}, C_L = 15 \text{ pF}$		-	4	-	-	-	ns
		V _{CC} = 3.0 V to 3.6 V		-	5 <mark>[2]</mark>	10	-	12	ns
t _{PHL}	HIGH to LOW	nMR to nQx; see Figure 9			1	l		1	
	propagation delay	V _{CC} = 1.2 V		-	70	-	-	-	ns
		V _{CC} = 2.0 V		-	24	44	-	54	ns
		V _{CC} = 2.7 V		-	18	33	-	40	ns
		$V_{CC} = 3.3 \text{ V, } C_L = 15 \text{ pF}$		-	11	-	-	-	ns
		V _{CC} = 3.0 V to 3.6 V		-	13[2]	26	-	32	ns
t _t	transition time	nQx; see Figure 8	[4]		1	l		1	
		V _{CC} = 2.0 V		-	-	-	-	-	ns
		V _{CC} = 2.7 V		-	-	-	-	-	ns
		V _{CC} = 3.0 V to 3.6 V		-	-	-	-	-	ns
t _W	pulse width	nCP HIGH or LOW; see Figure 8						1	
		V _{CC} = 2.0 V		34	10	-	41	-	ns
		V _{CC} = 2.7 V		25	8	-	30	-	ns
		V _{CC} = 3.0 V to 3.6 V		20	6 <mark>[2]</mark>	-	24	-	ns
		nMR HIGH; see Figure 9						1	
		V _{CC} = 2.0 V		34	12	-	41	-	ns
		V _{CC} = 2.7 V		25	9	-	30	-	ns
		V _{CC} = 3.0 V to 3.6 V		20	7[2]	-	24	-	ns
t _{rec}	recovery time	nMR to nCP; see Figure 9			1	II.	11	1	1
		V _{CC} = 1.2 V		-	5	-	-	-	ns
		V _{CC} = 2.0 V		5	2	-	5	-	ns
		V _{CC} = 2.7 V		5	2	-	5	-	ns
		V _{CC} = 3.0 V to 3.6 V		5	1[2]	-	5	-	ns

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50$ pF unless otherwise specified; for test circuit, see Figure 10.

Symbol	Parameter	Conditions		–40 '	°C to +8	5 °C	-40 °C to	Unit	
				Min	Typ[1]	Max	Min	Max	
f _{max} maximum frequency		see Figure 8							
		V _{CC} = 2.0 V		14	53	-	12	-	MHz
		V _{CC} = 2.7 V		19	72	-	16	-	MHz
		V _{CC} = 3.3 V, C _L = 15 pF		-	99	-	-	-	MHz
		V _{CC} = 3.0 V to 3.6 V		24	90[2]	-	20	-	MHz
C _{PD}	power dissipation capacitance	$V_I = GND$ to V_{CC}	[5]	-	23[2]	-	-	-	pF

- [1] All typical values are measured at T_{amb} = 25 °C.
- [2] Typical values are measured at $V_{CC} = 3.3 \text{ V}$.
- [3] t_{pd} is the same as t_{PLH} and t_{PHL} .
- [4] t_t is the same as t_{THL} and t_{TLH} .
- [5] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \sum (C_L \times V_{CC}{}^2 \times f_o)$$
 where:

f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$

10.1 Waveforms

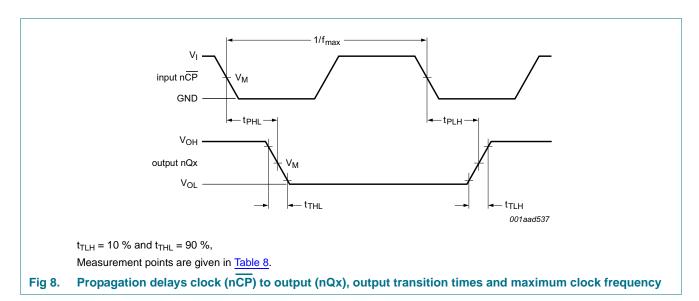
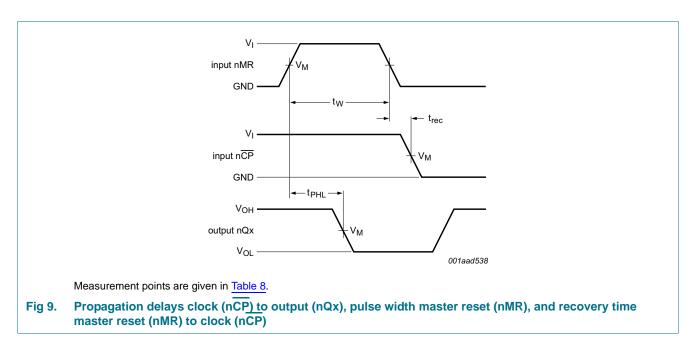
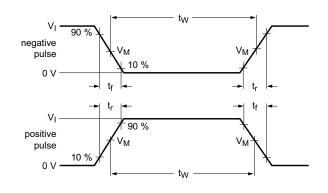
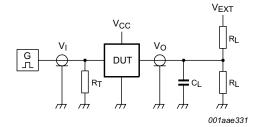


Table 8. Measurement points

Supply voltage V _{CC}	Input	Output	Output					
	V _M	V _M	V _X	V _Y				
< 2.7 V	0.5V _{CC}	0.5V _{CC}	$V_{OL} + 0.1V_{CC}$	V _{OH} – 0.1V _{CC}				
2.7 V to 3.6 V	1.5V _{CC}	1.5V _{CC}	$V_{OL} + 0.3V_{CC}$	$V_{OH} - 0.3V_{CC}$				







Test data is given in Table 9.

Definitions test circuit:

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

 C_L = Load capacitance including jig and probe capacitance.

R_L = Load resistance.

S1 = Test selection switch.

Fig 10. Test circuit for measuring switching times

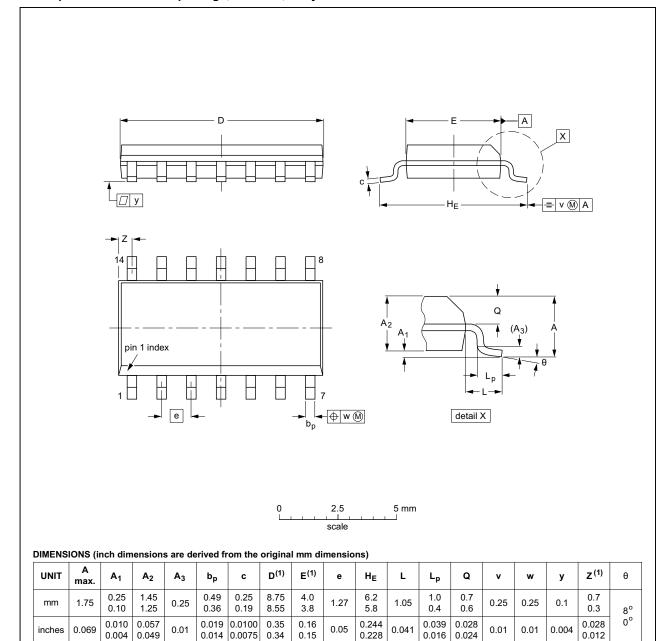
Table 9. Test data

Supply voltage	Input		Load	V _{EXT}	
V _{CC}	V _I	t _r , t _f	CL	R _L	t _{PHL} , t _{PLH}
< 2.7 V	V_{CC}	≤ 2.5 ns	50 pF	1 kΩ	open
2.7 V to 3.6 V	2.7 V	≤ 2.5 ns	15 pF, 50 pF	1 kΩ	open

11. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

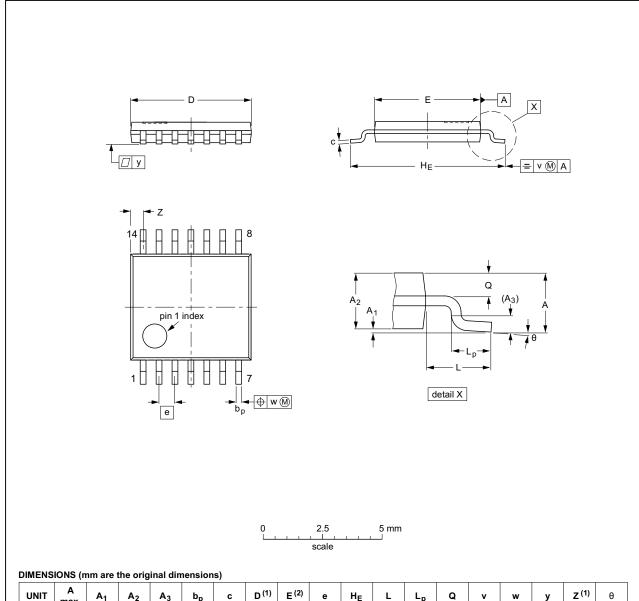
OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT108-1	076E06	MS-012				99-12-27 03-02-19

Fig 11. Package outline SOT108-1 (SO14)

74LV393_Q100

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



	UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D (1)	E (2)	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
ľ	mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT402-1		MO-153				99-12-27 03-02-18
301402-1		WO-133				

Fig 12. Package outline SOT402-1 (TSSOP14)

74LV393_Q100

12. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MIL	Military
MM	Machine Model

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LV393_Q100 v.2	20140917	Product data sheet	-	74LV393_Q100 v.1
Modifications:	• Figure 10 and Table 9 updated because of a missing load resistance in the test circuit.			
74LV393_Q100 v.1	20140526	Product data sheet	-	-

14. Legal information

14.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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74LV393-Q100

Dual 4-bit binary ripple counter

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